



1374.20289RC6

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicants: H. MAEJIMA, et al.

Serial No: 09/704,529

Filed: November 3, 2000

Title: WAFER HAVING CHAMFERED BEND PORTIONS IN THE JOINT REGIONS BETWEEN THE CONTOUR OF THE WAFER AND THE CUT-AWAY PORTION OF THE WAFER

Group: 2814

Examiner: L. PHAM

AMENDMENT AFTER FINAL REJECTION

Box: AF  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

January 29, 2007

Sir:

In response to the Office Action dated December 5, 2006, please amend the above-identified application as listed below and as set forth on the following pages:

**Amendments to the Claims**

Remarks are included following the amendments